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**CHIP-PACKAGING WITH BONDING OPTIONS HAVING A PLURALITY OF  
PACKAGE SUBSTRATES**

Appl. No. : 10/709,427 Confirmation No. 3426  
Applicant : Cheng-Yen Huang  
Filed : May 5, 2004  
TC/A.U. : 2822  
Examiner : Prenty, Mark V  
Docket No. : FTCP0036USA0  
Customer No. : 27765

Commissioner for Patents  
P.O. Box 1450  
Alexandria VA 22313-1450

**AMENDMENT**

5 Sir:

In response to the Office action of March 31, 2006, please amend the above-identified application as follows:

Amendments to the Specification begin on page 2 of this paper.

10 Amendments to the Claims are reflected in the listing of claims which begins on page 8 of this paper.

Amendments to the Drawings begin on page 10 of this paper and include two new sheets.

Remarks/Arguments begin on page 11 of this paper.

An Appendix including amended drawing figures is attached following page 14 of this paper.